

Dual N-Channel 60 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (mΩ) (Typ.)	I _D (A) ^a	Q _g (Typ.)			
60	12 at V _{GS} = 10 V	- 38	50 nC			
	16 at V _{GS} = 4.5 V	36				

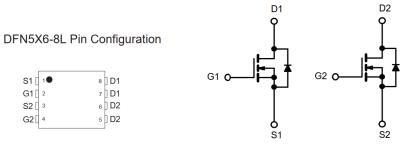
FEATURES

- DT-Trench Power MOSFET
- 100 % R_g and UIS Tested



APPLICATIONS

- 12 V Automotive systems
- · Motors, lamps and solenoid control
- · Transmission control



Top View

S1 [1 •

G1[

S2 [3 G2[

N1-Channel MOSFET

N2-Channel MOSFET

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	60	V	
Gate-Source Voltage		V _{GS}	± 20	v
	T _C = 25 °C		38ª	
Continuous Drain Current (T _J = 175 °C)	T _C = 70 °C		32	
Continuous Diam Current (1) = 175 C)	T _A = 25 °C	I _D	25 ^{b, c}	A
	T _A = 70 °C		18 ^{b, c}	
Pulsed Drain Current		I _{DM}	164	
Avalanche Current Pulse	L = 0.1 mH	I _{AS}	31	
Single Pulse Avalanche Energy	L = 0.11111	E _{AS}	60	mJ
Continuous Source-Drain Diode Current	T _C = 25 °C	I-	30 ^a	А
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	25 ^{b, c}	
	T _C = 25 °C		55 ^a	
Maximum Dawar Disaination	T _C = 70 °C	P _D	35	W
Maximum Power Dissipation	T _A = 25 °C	T D	35 ^{b, c}	
	T _A = 70 °C		22 ^{b, c}	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	35	45	°C/W		
Maximum Junction-to-Case	Steady State	R _{thJC}	5	8	- C/W		

Notes:

- a. Based on T_C = 25 °C. b. Surface mounted on 1" x 1" FR4 board. c. t = 10 s.
- d. Maximum under steady state conditions is 90 °C/W.

Rev. C



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Parameter	Symbol	Test Conditions	Min .	Тур.	Max.	Unit	
Static				•	•		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V, } I_{D} = 250 \mu\text{A}$	60			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA		55		mV/°(
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	10 - 200 μΑ		-6.3		illv/ C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1		3	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zoro Cato Voltago Proin Current	1	$V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}$	1		1		
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			10	μA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	38			Α	
Drain-Source On-State Resistance ^a	P	$V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$		12	17	mΩ	
Dialii-Source Oil-State Resistance	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$		16	25		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 10 V,I _D = 10 A		50		S	
Dynamic ^b							
Input Capacitance	C _{iss}			2750		pF	
Output Capacitance	C _{oss}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		110			
Reverse Transfer Capacitance	C _{rss}			101			
Total Gate Charge	Qg			52			
Gate-Source Charge	Q _{qs}	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$		4.8		nC	
Gate-Drain Charge	Q _{gd}			7.6			
Gate Resistance	R _g	f = 1 MHz		2.0		Ω	
Turn-On Delay Time	t _{d(on)}			8			
Rise Time	t _r	$V_{DD} = 30 \text{ V, R}_{L} = 5.4 \Omega$		12			
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		15			
Fall Time	t _f			8			
Turn-On Delay Time	t _{d(on)}			10		ns	
Rise Time	t _r	V_{DD} =30 V, R $_{L}$ = 5.4 Ω		28			
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		30			
Fall Time	t _f			16		1	
Drain-Source Body Diode Characteristics	5						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			38	_	
Pulse Diode Forward Current ^a	I _{SM}				164	A	
Body Diode Voltage	V _{SD}	I _S = 1 A		0.6	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			20		ns	
Body Diode Reverse Recovery Charge	Q _{rr}	L = 10 A di/dt = 100 A/vs T = 25 °C		25		nC	
Reverse Recovery Fall Time	t _a	$I_F = 10 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s, T}_J = 25 ^{\circ}\text{C}$		20			
Reverse Recovery Rise Time	t _b	-		8		ns	

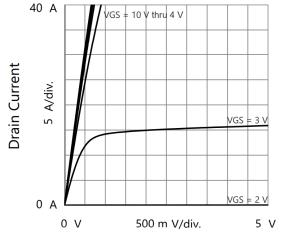
Notes:

- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

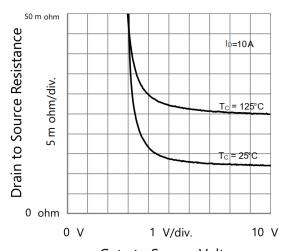
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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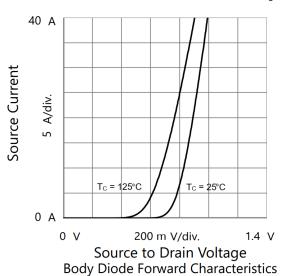
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

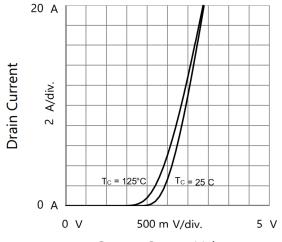


Drain to Source Voltage Output Characteristics

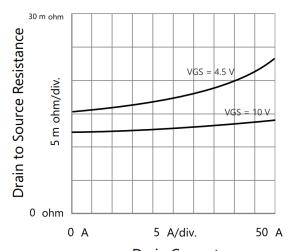


Gate to Source Voltage
Drain to Source Resistance vs. Gate to Source Voltage

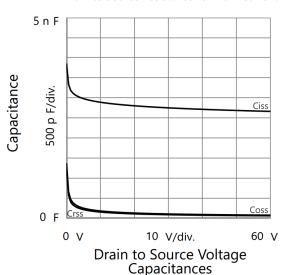




Gate to Source Voltage Transfer Characteristics



Drain Current
Drain to Source Resistance vs. Drain Current

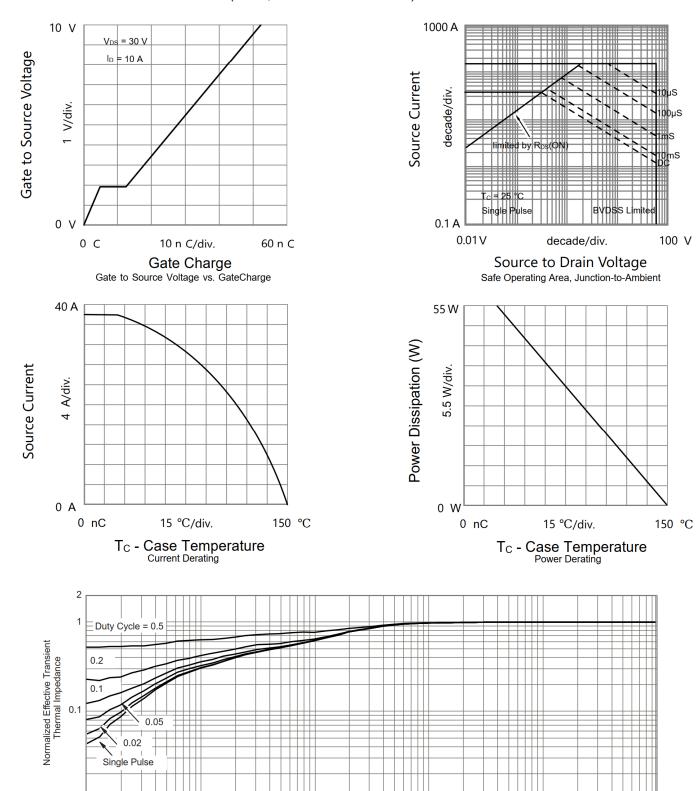


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Square Wave Pulse Duration (sec)

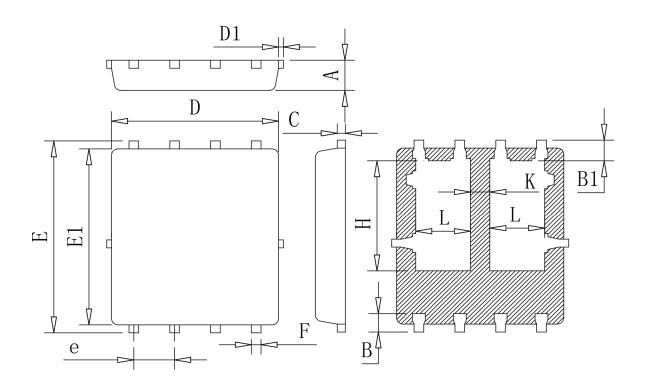
Normalized Thermal Transient Impedance, Junction-to-Case

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DFN5X6-8L-D PACKAGE OUTLINE



COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

Symbol	Min	Тур	Max
A	0.85	0.95	1.05
В	0.46	0.58	0.73
B1	0.52	0.65	0.78
С	0.18	0.254	0.32
D	4.70	5.20	5.50
D1	-	-	0.18
Е	5.75	6.05	6.35
E1	5.35	5.65	5.85
e	1.15	1.27	1.50
F	0.15	0.30	0.50
Н	3.15	3.47	3.80
L	1.35	1.70	2.10
K	0.35	0.60	1.00



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